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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status A	Active		
Core Processor e	2200z4		
Core Size 3	32-Bit Dual-Core		
Speed 1	.80MHz		
Connectivity C	CANbus, Ethernet, FlexRay, LINbus, SPI, UART/USART		
Peripherals D	DMA, LVD, POR, WDT		
Number of I/O -			
Program Memory Size 1	5MB (1.5M x 8)		
Program Memory Type Fl	LASH		
EEPROM Size -			
RAM Size 1	92K x 8		
Voltage - Supply (Vcc/Vdd) 3	3.15V ~ 5.5V		
Data Converters A	A/D 64x12b		
Oscillator Type Ir	nternal		
Operating Temperature -4	40°C ~ 125°C (TA)		
Mounting Type S	Surface Mount		
Package / Case 2	257-LFBGA		
Supplier Device Package 2	257-LFBGA (14x14)		
Purchase URL h	https://www.e-xfl.com/product-detail/nxp-semiconductors/spc5742pk1ammm8		

Email: info@E-XFL.COM

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MPC574xP Microcontroller

Power Architecture[®]-based MCU for Automotive and Industrial Applications

Product One-Sheet



Performance—2 x e200z4 cores in delayed lockstep operating up to 200 MHz, embedded floating point unit, 32-channel eDMA in delayed lockstep

High Reliability—AEC-Q100, automotive quality, up to 135°C ambient temperature

Abundant Features—FlexCAN, LINFlexD, DSPI, SENT, LFAST SIPI support, Dual-channel FlexRay™, Ethernet

Functional Safety—Built to support functional safety (ISO 26262/ASIL D and IEC 61508 SIL3), end-to-end ECC

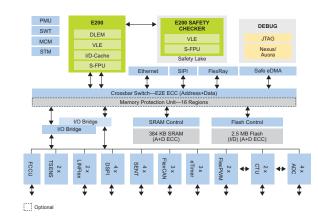
MPC574xP Specifications

Flash	Up to 2.5 MB	Timer/PWM	2 x FlexPWM w/ 4 x (2+1) ch.	
RAM	Up to 384 KB	Other Timer	2 x eTimer w/ 6-ch., 1 x PIT / STM w/ 4-ch., SWT	
Core	2 x e200z4 lockstep	Analog	4 x 12 bit ADC w/ 16-ch.	
Speed	Up to 200 MHz		SENT, ADC, FlexCAN, FlexRay, LinFlex, DSPI, FlexPWM and SIPI/LFAST 3G IF	
Package	144 LQFP/257 BGA	Comm		
Op Range	3.15 V to 5.5 V	C ()	Core/DMA lockstep, e2eECC,	
Temp	-40°C to up to 135°C	Safety	duplicate periphery, LBIST/ MBIST, ADC self-test, FCCU	

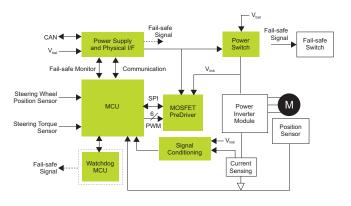
Orderable Samples

Part Number	Temp. Range	Flash	SRAM	Package
SPC5744P	-40°C to 125°C	2.5 MB	384 KB	144 LQFP/257 BGA
SPC5743P	-40°C to 125°C	2 MB	256 KB	144 LQFP/257 BGA
SPC5742P	-40°C to 125°C	1.5 MB	192 KB	144 LQFP/257 BGA
SPC5741P	-40°C to 125°C	1 MB	128 KB	144 LQFP/257 BGA

MPC574xP Block Diagram



Motor Control Application



Success Stories

- Electronic power steering
- Wireless charging
- Shock controller
- DC-DC converter

Target Applications

- Electric power steering (EPS)
- Airbag system
- Safety domain control
- Safety motor controller
- Active driver assistance system
- Adaptive cruise control
- Braking and stability control
- Active suspension

Enablement Tools

- Development hardware:
- Mother evaluation board
- Daughter adapter boards
- Runtime software:
- Flash and EEPROM driver
- Compiler: Green Hills, Wind River
- Debugger: Lauterbach, iSystem, PLS





www.nxp.com/MPC574xP

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